

A2 tolerance, after the coil is connected to a circuit board, the spacing of the loops is adjusted, such that the loop spacing is outside the manufacturing tolerance of the loops.

IN THE CLAIMS

Please amend the claims as follows:

A3 1. (amended) An electronic package [(110)], comprising:
a coil [(112)] of wire bent into a plurality of sequential loops;
terminals [(113,114)] for attaching the coil to a circuit board; and
means [(115)] including a surface of material connected to the coil extending [over] between a plurality of the [coils] for pick-up using a vacuum probe of a head of a pick-and-place machine, and adapted for adjusting [the spacing] a position of the loops of the coils for tuning the coil, after the coil is attached to a circuit board.

Cancel claims 2-3.

A4 35 4. (amended) The package of claim 1 in which the surface includes a portion which can be removed from the wire coil without damaging the wire coil, so that a position of [the spacing between] the loops of the coil can be changed to tune the coil.

5. (amended) The package of claim 1 in which the surface does not extend [onto] between all [some] of the loops of the coil so that a position of [the spacing between] the loops, between which the surface does not extend, can be changed by bending the coil for tuning the coil.

6. (amended) The package of claim 1 in which the surface is sufficiently weak or flexible so that the loops [on] between which the surface extends can be easily bent to adjust a

position of [the spacing between] the loops sufficient for tuning the coil without otherwise damaging the coil.

7. (amended) the package of claim 1 in which the surface is degraded by exposure to a solvent that can be used to wash the circuit board after the package is connected to the circuit board, whereby the loops can be bent to adjust a position of [change the spacing between] the loops for tuning the coil.

8. the package of claim 7 in which the surface is degraded by exposing the surface to water and at least a portion of a material of the surface can be removed by washing in water without damaging the coils.

9. The package of claim 1 in which the surface is degraded by heating the circuit board after which the separation between the loops can be changed by bending the loops for tuning the coil.

10. (amended) The package of claim 9 in which the material of the surface flows when exposed to soldering temperature of eutectic Pb/Sn alloy, so that after heating the circuit board to reflow the solder at least some of the [coils] loops become [mechanically separable to allow] bendable for tuning the coil.

11. (amended) The package of claim 9 in which the material of the surface sublimates when exposed to soldering temperature of eutectic Pb/Sn alloy, so that after reflow soldering the circuit board at least some of the [coils] loops become [mechanically separable] bendable for tuning the coil.

12. (amended) The package of claim 6 in which the surface is sufficiently soft and arranged, so that it can be easily cut between loops of the coil using [snippers] a tool without damaging the coil and then [the spacing between two] a position of the loops of the coil can be adjusted to tune the

coil.

Cancel claims 13-14.

Please add the following new claim:

15. The package of claim 1 in which:
- the surface includes a portion which can be removed from the wire coil without damaging the wire coil so that a spacing between the loops of the coil can be changed to tune the coil;
 - the surface does not extend onto some of the loops of the coil so that a position of the loops can be changed by bending the coil for tuning the coil;
 - the surface is sufficiently weak or flexible so that the loops on which the surface extends can be easily bent to adjust a position of the loops sufficient for tuning the coil without otherwise damaging the coil;
 - the surface is degraded by exposure to a solvent that can be used to wash the circuit board after the package is connected to the circuit board whereby the loops can be bent for adjusting a position of the loops for tuning the coil;
 - the surface is degraded by exposing the surface to water and at least a portion of a material of the surface can be removed by washing in water without damaging the coils;
 - the surface is degraded by heating the circuit board after which the separation between the loops can be changed by bending the loops for tuning the coil;
 - the material of the surface flows when exposed to soldering temperature of eutectic Pb/Sn alloy so that after heating the circuit board to reflow the solder at least some of the coils become mechanically separable for tuning the coil;
 - the material of the surface sublimates when exposed to soldering temperature of eutectic Pb/Sn alloy so that after reflow soldering the circuit board at least some of the coils become mechanically separable for tuning the coil;
 - the surface is sufficiently soft and arranged so that it